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Onsemi

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The FMS6141 may be directly driven by a DC-coupled DAC output or an AC-coupled signal. Internal diode clamps and bias circuitry may be used if an AC-coupled input is required (see Application Information for details).

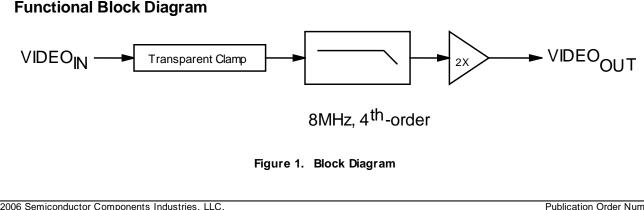
The FMS6141's output can drive an AC- or DC-coupled single (150 Ω) or dual (75 Ω) load. DC-coupling the output removes the need for output coupling capacitors. The input DC level is offset approximately +280 mV at the output (see Application Information for details).

Related Applications Notes

Description

solutions.

- http://www.onsemi.com/pub/Collateral/AN-6041.pdf.pdf
- http://www.onsemi.com/pub/Collateral/AN-6024.pdf.pdf



ON Semiconductor®

Features

75O)

Capacitors

Applications

DVD Players

HDTVs

Single Supply

(2 V_{pp}, 150 Ω)

Single 4th-Order 8 MHz (SD) Filter

Transparent Input Clamping

AC- or DC-Coupled Input

AC- or DC-Coupled Output

Robust 8 kV ESD Protection

Cable Set-Top Boxes

Satellite Set-Top Boxes

Video On Demand (VOD)

Personal Video Recorders (PVR)

Drives Single, AC- or DC-coupled, Video Loads

DC-Coupled Output Eliminates AC-Coupling

Lead-Free Packages: SOIC-8 or SC70-5

Drives Dual, AC- or DC-coupled, Video Loads (2V_{pp},

FMS6141

Low-Cost, Single-Channel 4th-Order

Standard Definition Video Filter Driver

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Single-Channe
4 th -Order
141 — Low-Cost, Single-Channel 4 th -Order Standard Definition Video Filter Driver
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Driver

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FMS6141CSX	-40°C to +85°C	8-Lead, Small Outline Integrated Circuit (SOIC)	Tape and Reel
FMS6141S5X	-40°C to +85°C	5- Lead SC70 Package	Tape and Reel

Pin Configurations

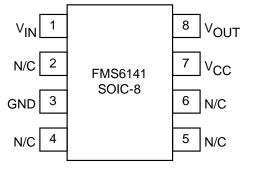


Figure 2. SOIC-8

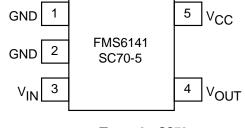


Figure 3. SC70

Pin Definitions

SOIC Pin #	SC70 Pin#	Name	Description
1	3	V _{IN}	Video Input
2		N/C	No Connect
3	1, 2	GND	Must Be Connected to Ground
4		N/C	No Connect
5		N/C	No Connect
6		N/C	No Connect
7	5	V _{cc}	+5V Supply, Do Not Float
8	4	V _{OUT}	Filtered Video Output

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{cc}	DC Supply Voltage	-0.3	6.0	V
V _{IO}	Analog and Digital I/O	-0.3	V _{CC} +0.3	V
I _{OUT}	Output Current, Do Not Exceed		50	mA

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
T _A	Operating Temperature Range	-40		85	°C
V _{cc}	V _{cc} Range	4.75	5.00	5.25	V

ESD Information

Symbol	Parameter	Value	Unit
ESD	Human Body Model, JESD22-A114	8.0	kV
ESD	Charged Device Model, JESD22-C101	1.5	kV

Reliability Information

Symbol	Parameter		Min.	Тур.	Max.	Unit
TJ	Junction Temperature				+150	°C
T _{STG}	Storage Temperature Range		-65		+150	°C
TL	Lead Temperature (Soldering, 10 s)				300	°C
Θ _{JA} Thermal Resistance (JEDEC Standard Multi-Layer Test Boards, Still Air)	SOIC-8		115		°C/W	
	(JEDEC Standard Multi-Layer Test Boards, Still Air)	SC70-5		332		°C/W

DC Specifications

 $T_A = 25^{\circ}$ C, $V_{CC} = 5.0$ V, $R_S = 37.5 \Omega$; input is AC coupled with 0.1 µF; output is AC coupled with 220 µF into a 150 Ω load; unless otherw ise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _{cc}	Supply Current ⁽¹⁾	No Load		7	12	mA
V _{IN}	Video Input Voltage Range	Referenced to GND if DC-Coupled		1.4		V_{pp}
PSRR	Pow er Supply Rejection Ratio	DC		40		dB

Note:

1. 100% tested at 25°C

AC Electrical Specifications

 $T_A = 25^{\circ}$ C, $V_{CC} = 5.0$ V, $R_S = 37.5 \Omega$; input is AC coupled with 0.1 µF; output is AC coupled with 220 µF into a 150 Ω load; unless otherw ise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
AV	Channel Gain ⁽²⁾		5.6	6.0	6.4	dB
f _{1dB}	-1dB Bandw idth ⁽²⁾		4.0	6.5		MHz
f _c	-3dB Bandw idth			7.7		MHz
f _{SB}	Attenuation (Stopband Reject)	f = 27 MHz		42		dB
dG	Differential Gain			0.4		%
dφ	Differential Phase			0.4		0
THD	Output Distortion (all channels)	V_{OUT} = 1.8 V_{pp} , 1 MHz		0.4		%
SNR	Signal-to-Noise Ratio	NTC-7 Weighting; 100 kHz to 4.2 MHz		75		dB
t _{pd}	Propagation Delay	Delay from input to output, 4.5 MHz		55		ns

Note:

2. 100% tested at 25°C

Application Information

Input Considerations

The FMS6141 Low-Cost Video Filter provides 6 dB (2X) gain from input to output. The device provides an internal diode clamp to support AC-coupled input signals. In this configuration, a 0.1 μ F ceramic capacitor is used to AC couple the input signal. If the input signal does not go below ground, the clamp is inactive; but if the input signal goes below ground, the clamp circuitry sets the bottom of the sync tip (or low est voltage) to just below ground. The input level set by the clamp, combined with the internal DC offset, keeps the output signal within an acceptable range. This clamp feature also allows the FMS6141's input to be directly driven (DC-coupled) by a ground referenced DAC output. Figure 4 shows typical DC voltage levels for the input and output signals when driven by a DC-coupled DAC output or an AC-coupled and clamped Y, CV signal.

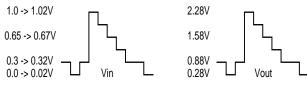


Figure 4. Typical DC Voltage Levels

Output Considerations

The FMS6141 outputs will be DC offset from the input by 150 mv therefore V_{OUT} = 2*V_{IN} DC+150 mv. This offset is required to obtain optimal performance from the output driver and is held at the minimum value in order to decrease the standing DC current into the load. Since the FMS6141 has a 2x (6 dB) gain, the output is typically connected via a 75 Ω series back-matching resistor follow ed by the 75 Ω video cable. Because of the inherent divide by two of this configuration, the blanking level at the load of the video signal is alw ays less then 1 V. When AC-coupling the output ensure that the coupling capacitor of choice will pass the low est frequency content in the video signal and that line time distortion (video tilt) is kept as low as possible.

The selection of the coupling capacitor is a function of the subsequent circuit input impedance and the leakage current of the input being driven. In order to obtain the highest quality output video signal the series termination resistor must be placed as close to the device output pin as possible. This greatly reduces the parasitic capacitance and inductance effect on the FMS6141 output driver. Recommend distance from device pin to place series termination resistor should be no greater than 0.1 inches.

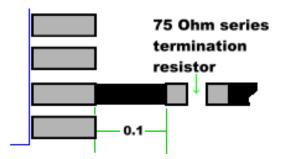
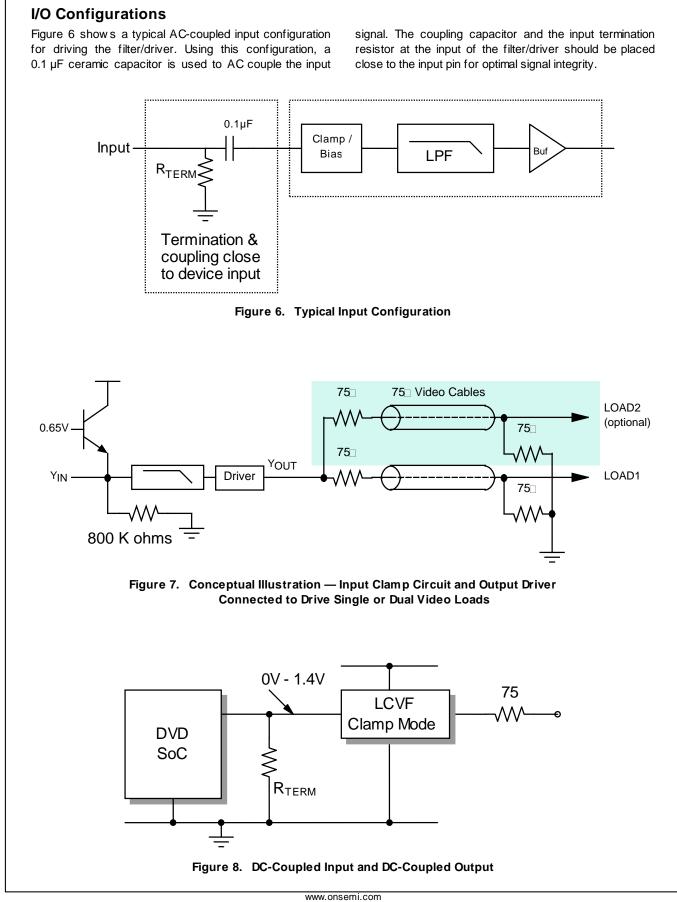
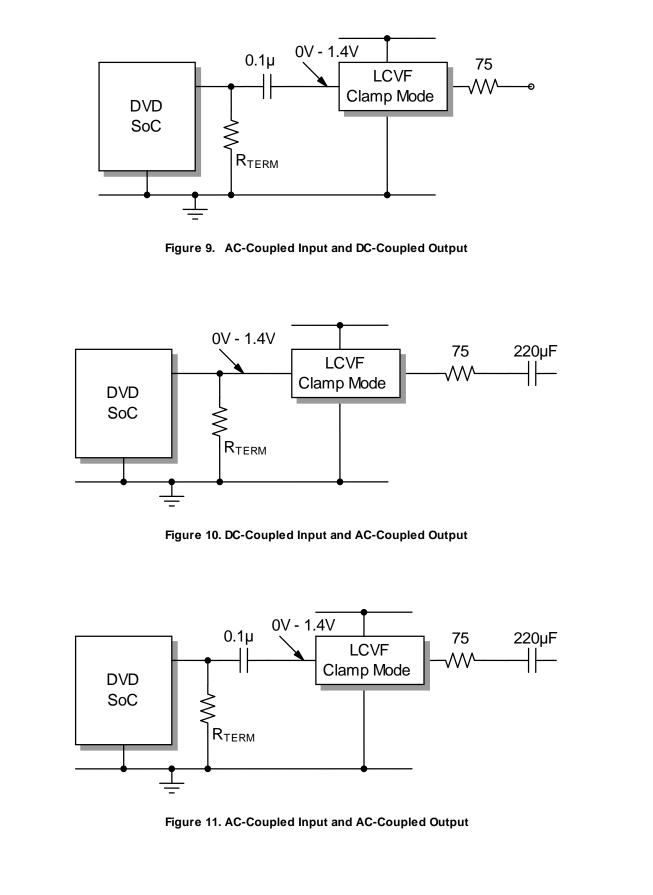


Figure 5. Distance from Device Pin to Series Termination Resistor



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FMS6141 — Low-Cost, Single-Channel 4th-Order Standard Definition Video Filter Driver

Layout Considerations

General layout and supply bypassing play a major role in high-frequency performance and thermal characteristics. ON Semiconductor offers a demonstration board for the FMS6141 to guide layout and aid device evaluation. The demo board is a four-layer board with full power and ground planes. Following this layout configuration provides optimum performance and thermal characteristics for the device. For the best results, follow the steps and recommended routing rules listed below.

Recommended Routing/Layout Rules

- Do not run analog and digital signals in parallel.
- Use separate analog and digital pow er planes to supply pow er.
- Traces should run on top of the ground plane at all times.
- No trace should run over ground/pow er splits.
- Avoid routing at 90-degree angles.
- Minimize clock and video data trace length differences.
- Include 10 µF and 0.1 µF ceramic pow er supply bypass capacitors.
- Place the 0.1 µF capacitor within 0.1 inches of the device pow er pin.
- Place the 10 µF capacitor within 0.75 inches of the device pow er pin.
- For multilayer boards, use a large ground plane to help dissipate heat.
- For two-layer boards, use a ground plane that extends beyond the device body by at least 0.5 inches on all sides. Include a metal paddle under the device on the top layer.
- Minimize all trace lengths to reduce series inductance.

Thermal Considerations

Since the interior of most systems, such as set-top boxes, TVs, and DVD players are at +70°C; consideration must be given to providing an adequate heat sink for the device package for maximum heat dissipation. When designing a system board, determine how much pow er each device dissipates. Ensure that devices of high power are not placed in the same location, such as directly above (top plane) and below (bottom plane) each other on the PCB.

PCB Thermal Layout Considerations

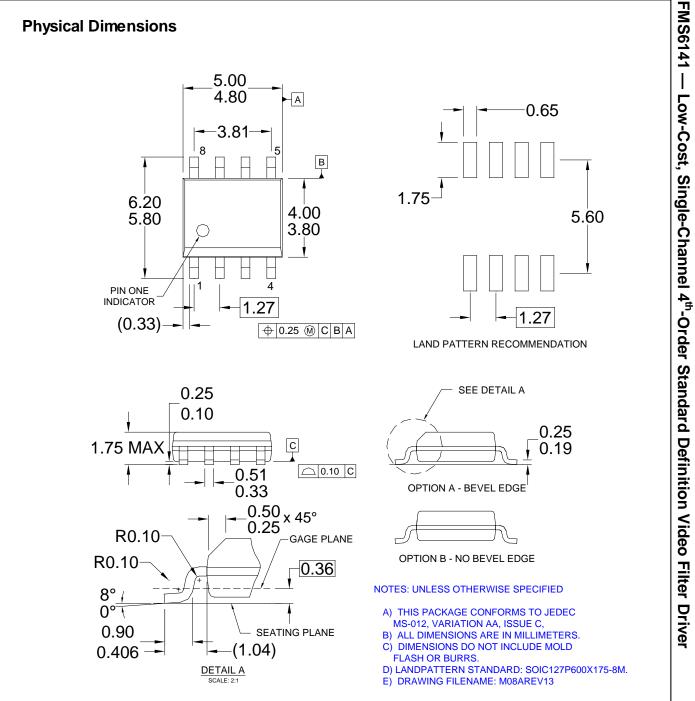
- Understand the system power requirements and environmental conditions.
- Maximize thermal performance of the PCB.
- Consider using 70 µm of copper for high-power designs.
- Make the PCB as thin as possible by reducing FR4 thickness.
- Use vias in pow er pad to tie adjacent layers together.
- Remember that baseline temperature is a function of board area, not copper thickness.
- Modeling techniques can provide a first-order approximation.

Power Dissipation

Consider the FMS6141's output drive configuration when calculating overall power dissipation. Care must be taken not to exceed the maximum die junction temperature. The following example can be used to calculate the FMS6141's power dissipation and internal temperature rise.

$$\begin{split} T_J &= T_A + P_{CHANNEL} \; \Theta_{JA} \\ w \; here \; P_{CHANNEL} = V_{CC} \bullet I_{CH} + (V_O^2/R_L) \\ V_O &= 2V_{IN} + 0.280V \\ I_{CH} &= I_{CC} + (V_O/R_L) \\ V_{IN} &= RMS \; value \; of \; input \; signal \\ I_{CC} &= 7mA \\ V_S &= 5V \\ R_L &= channel \; load \; resistance \end{split}$$

The FMS6141 is specified to operate with output currents typically less than 50 mA, which is more than sufficient for a dual (75 Ω) video load. The internal amplifiers of the FMS6141 are current limited to a maximum of 100 mA and can withstand a brief-duration short-circuit condition, but this capability is not guaranteed.





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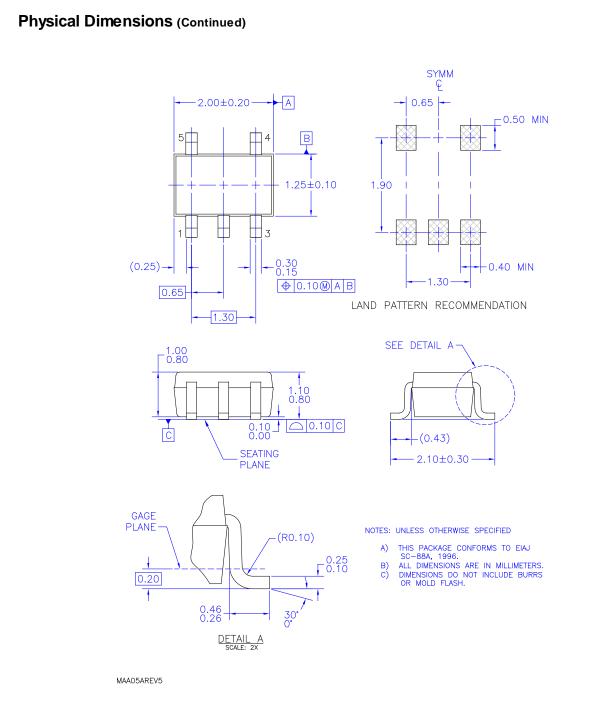


Figure 13. SC70-5 Package

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